



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants : Trammel, et al.

Serial No. : 09/940,567

Examiner: Vockrodt, J.

Filed : 8/27/01

Group Art Unit: 2822

For : A PLANAR LIGHTWAVE CIRCUIT ACTIVE DEVICE METALLIZATION PROCESS

RESPONSE TO OFFICE ACTION

Assistant Commissioner for Patents & Trademarks  
Washington, D.C. 20231

Sir:

In response to the Office Action mailed on 4/3/03, please consider the following  
remarks:

IN THE CLAIMS

Please amend the claims as follows:

1. (Currently Amended) A method for making a resistive heater for a planar lightwave circuit, the method comprising ~~the steps of~~:
- a) depositing a resistive layer on a top clad of a planar lightwave circuit;
  - b) depositing an interconnect layer onto the resistive layer, wherein the resistive layer comprises tungsten and the interconnect layer comprises aluminum;
  - e) etching the interconnect layer to define a heater interconnect, wherein the heater interconnect is disposed over the resistive layer and has a first width;

7/B Andt  
10-21-03  
A. Waller

Entered  
11-3-03

TO 2822 UNIT 2822  
OCT 10 2003  
RECEIVED

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